

## Technical Datasheet (PETGHW807)

<b>APPLICATION:</b>	This PETGH HIGH TEMPERATURE WHITE CORE is the result of the mixture of specific PETG resins which make this material easy to be implemented by any card manufacturers. It has been designed specifically for the production of high added value cards that need to work under extrem conditions and high temperature. This material gives to the card body structure a very high resistance and long durability.		
<b>APPEARANCE:</b>	WHITE, BOTH SIDES MATT.		
<b>THICKNESS ( μm )</b>	120 - 330 μm		
<b>THICKNESS TOLERANCE ON 100% OF READINGS</b>	Between 120 - 200 μm	± 7 %	
	Between 210- 280 μm	± 6 %	
	Between 290- 330 μm	± 5 %	
<b>PROPERTIES</b>	<b>TEST METHOD</b>	<b>RESPONSE VALUE</b>	
<b>VICAT SOFTENING POINT (5Kg Load in oil as stacked samples)</b>	UNI EN ISO 306 VSTB50	120 ± 2 °C	
<b>DENSITY</b>	ISO 1183-1	1.32 ± 0.05 g/cm <sup>3</sup>	
<b>SURFACE TENSION</b>	ISO 8296	Best Printing side ≥ 36 mN/m	
		Reverse side ≥ 33 mN/m	
<b>SURFACE ROUGHNESS</b>	ASIA Tech Internal Test	Ra ( μm )	Between 0.8~1.8μm
		Rz ( μm )	Between 5~10μm
<b>GLOSSINESS DEGREE in %</b>	ASIA Tech Internal Test	Thickness ≤ 300μm	-
		Thickness ≥ 310μm	-
<b>TENSILE STRENGTH</b>	UNI EN ISO 527-3/2/50	CD MPa ≥	-
		MD Mpa ≥	-
<b>HEAT SHRINKAGE in % (140±2 °C for 10 Minutes)</b>	ASIA Tech Internal Test	Thickness 120-200μm	MD≥ -14   CD≤ +6 %
	ASIA Tech Internal Test	Thickness 210-280μm	MD≥ -5   CD≤ +4 %
	ASIA Tech Internal Test	Thickness 290-330μm	MD≥ -4   CD≤ +3 %
<b>TENSILE IMPACT STRENGTH</b>	ISO 8256	> 500 HJ/m <sup>2</sup>	

\* **Shelf Life:** 2 years in the original packaging

\*\* **Recommended Storage Conditions:** Between 15~30 °C and humidity between 40~60%.

NO Direct sunlight exposure.